



Features

- Wide 4.5V to 28V Operating input Range
- 3A Continuous Output Current
- COT PSM Mode Control with Fast Transient Response
- 500KHz Switching Frequency
- Built-in Over Current Limit
- Built-in Over Voltage Protection
- PFM Mode for High Efficiency in Light Load
- Internal Soft start
- 100mΩ/50mΩ Low $R_{DS(ON)}$ Internal Power MOSFETs
- Output Adjustable from 0.6/0.8/0.765V
- No Schottky Diode Required
- Integrated internal compensation
- Available in ESOP8 Package
- -40°C to +85°C Temperature Range

Applications

- Automotive Systems
- Network Terminal Equipment
- Security Monitoring Camera
- Printer Systems
- Industrial Power Systems
- Distributed Power Systems

General Description

The TX943XA-30EP8R is a high frequency, synchronous, rectified, step-down, switch-mode converter with internal power MOSFETs. It offers a very compact solution to provide a 3A continuous output current over a wide input supply range, with excellent load and line regulation. COT PSM control operation

provides very fast transient response and easy loop design as well as very tight output regulation.

The TX943XA requires a minimal number of readily available, external components and is available in a space saving ESOP8 package

Typical Application

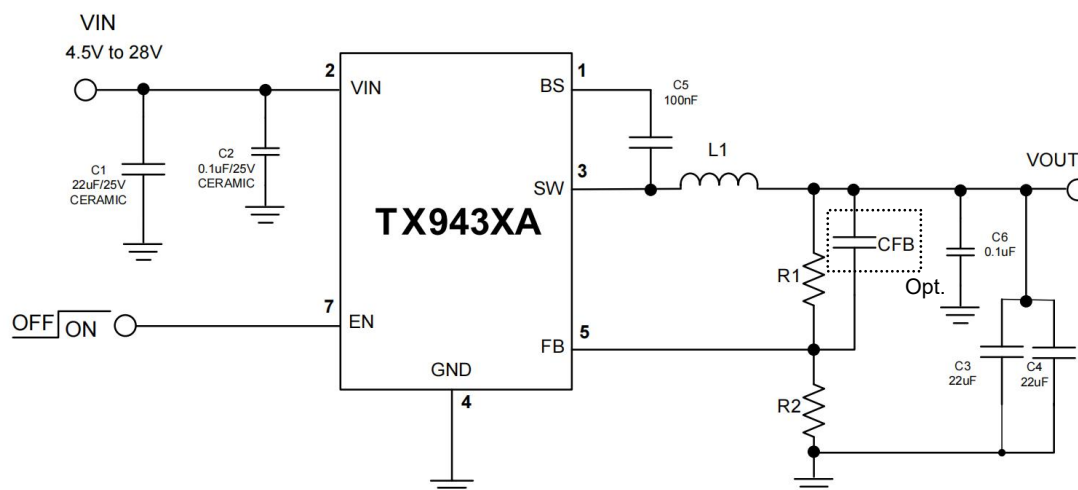
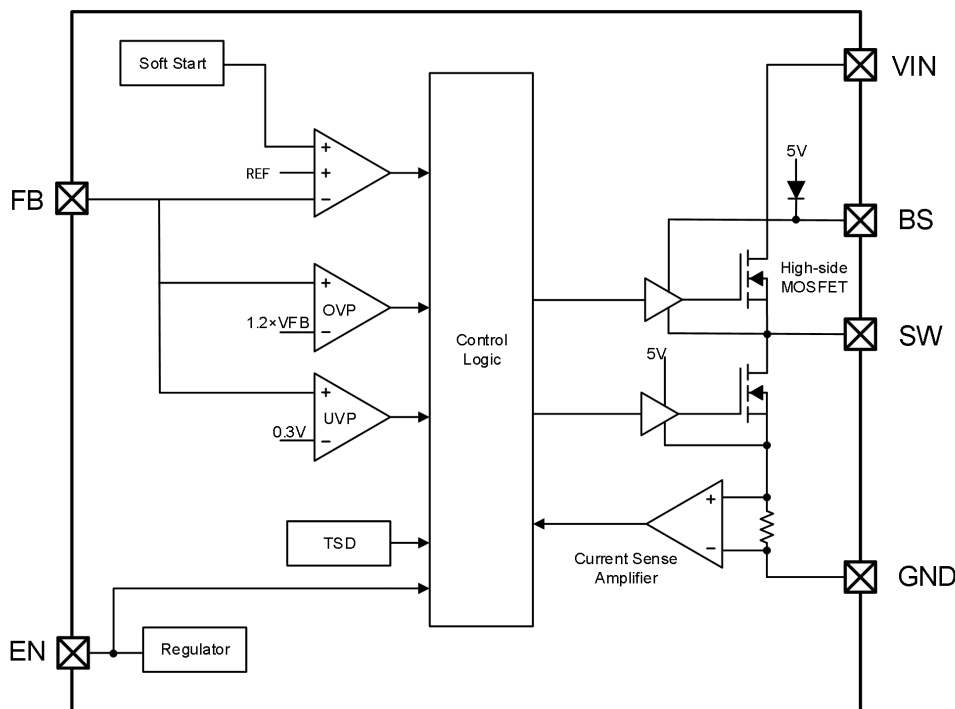


图 1. Basic Application Circuit



System Block Diagram



Functional Description

Internal Regulator

The TX943XA is an COT step down DC/DC converter that provides excellent transient response with no extra external compensation components. This device contains an internal, low resistance, high voltage power MOSFET,

and operates at a high 500KHz operating frequency to ensure a compact, high efficiency design with excellent AC and DC performance.

Under-Voltage Lockout (UVLO)

Under-voltage lockout (UVLO) protects the chip from operating at an insufficient supply voltage. UVLO protection monitors the internal regulator voltage. When

the voltage is lower than UVLO threshold voltage, the device is shut off. When the voltage is higher than UVLO threshold voltage, the device is enabled again.

Thermal Shutdown

Thermal shutdown prevents the chip from operating at exceedingly high temperatures. When the silicon die temperature exceeds 160°C, it shuts down the

whole chip. When the temperature falls below its lower threshold (Typ. 140°C) the chip is enabled again.

Internal Soft-Start

The soft-start is implemented to prevent the converter output voltage from overshooting during startup. When the chip starts, the internal circuitry generates a soft-start voltage (SS) ramping up from 0V to VFB. When it is lower

than the internal reference (REF), SS overrides REF so the error amplifier uses SS as the reference. When SS is higher than REF, REF regains control. The SS time is internally max to 1.5ms.



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28V 3A 500KHz COT PSM Sync Step-Down Regulator

Over Current Protection

The TX943XA has cycle-by-cycle over current limit when the inductor current valley value exceeds the set current limit threshold. Meanwhile, output voltage starts to drop until FB is below the Under-Voltage (UV) threshold. Once a UV is triggered, the TX943XA enters hiccup mode to periodically restart the part. This protection mode is

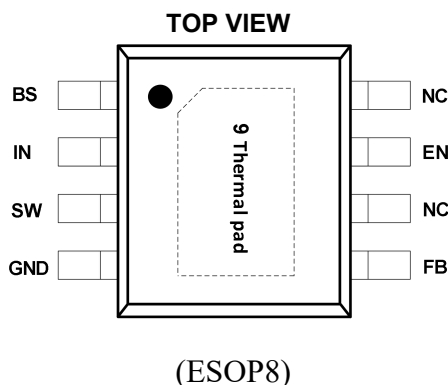
especially useful when the output is dead-short to ground. The average short circuit current is greatly reduced to alleviate the thermal issue and to protect the regulator. The TX943XA exits the hiccup mode once the over current condition is removed.

Startup and Shutdown

If both V_{IN} and EN are higher than their appropriate thresholds, the chip starts. The reference block starts first, generating stable reference voltage and currents, and then the internal regulator is enabled. The regulator provides stable supply for the remaining circuitries. Three events can shut down the chip: EN low, V_{IN} low and

thermal shutdown. In the shutdown procedure, the signaling path is first blocked to avoid any fault triggering. The comp voltage and the internal supply rail are then pulled down. The floating driver is not subject to this shutdown command.

Pin Description



PIN	NAME	FUNCTION
1	BS	Bootstrap. A capacitor connected between SW and BST pins is required to form a floating supply across the high-side switch driver.
2	IN	Power Supply Pin.
3	SW	Switching Pin.
4	GND	GROUND Pin.
5	FB	Adjustable Version Feedback input. Connect FB to the center point of the external resistor divider.
6、8	NC	Empty foot.
7	EN	Drive this pin to a logic-high to enable the IC. Drive to a logic-low to disable the IC and enter micro-power shutdown mode.
9	Thermal pad	The heat dissipation pads must be connected to GND and soldered onto the large-area PCB copper substrate to achieve maximum heat dissipation.



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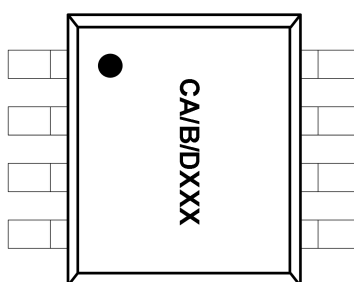
Order Information

TX94①②③-④⑤⑥⑦⑧

Designator	Symbol	Description
①	3	30V Maximum Voltage
②	6/7/8	6: 0.6V Feedback Voltage 7: 0.765V Feedback Voltage 8: 0.8V Feedback Voltage
②	A	500K Switching Frequency
③⑤	30	Output Current, 30=3A
⑥⑦	EP8	Package: ESOP8
⑧	R	RoHS / Pb Free
	G	Halogen Free

Marking	Model	Description	Package	T/R Qty.
CAXXX	TX9436A-30EP8R	TX9436A-30EP8R BUCK, 4.5-28V, 3.0A, 500KHz, VFB=0.6V, ESOP8	ESOP8	4000PCS
CBXXX	TX9437A-30EP8R	TX9437A-30EP8R BUCK, 4.5-28V, 3.0A, 500KHz, VFB=0.765V, ESOP8	ESOP8	4000PCS
CDXXX	TX9438A-30EP8R	TX9438A-30EP8R BUCK, 4.5-28V, 3.0A, 500KHz, VFB=0.8V, ESOP8	ESOP8	4000PCS

Marking Information



ESOP8
(TOP VIEW)

Top marking: CA/B/DXXX (device code: CA/CB/CD, lot number code: XXX)



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Absolute Maximum Ratings^{(1) (2)}

V_{IN}, EN, SW Voltage -0.3V ~ 32V
 Operating Temperature Range -40°C ~ +150°C
 FB, BS Voltages -0.3 ~ 6V
 Lead Temperature (Soldering, 10s) +260°C
 Power dissipation⁽³⁾ Internally Limited

Storage Temperature Range -55°C ~ 150°C
 ESD (Human Body Mode) HMB 2KV
 Thermal Resistance (R_{θJA}) 49 °C/W
 Thermal Resistance (R_{θJC}) 53 °C/W

Note 1: Exceeding these ratings may damage the device.

Note 2: The device is not guaranteed to function outside of its operating conditions.

Note 3: The maximum allowable power dissipation is a function of the maximum junction temperature, T_{J(MAX)}, the junction-to-ambient thermal resistance, R_{θJA}, and the ambient temperature, T_A. The maximum allowable power dissipation at any ambient temperature is calculated using: P_{D (MAX)} = (T_{J(MAX)} - T_A)/R_{θJA}. Exceeding the maximum allowable power dissipation causes excessive die temperature, and the regulator goes into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at T_J=160°C (typical) and disengages at T_J= 140°C (typical).

Electrical Characteristics^{(1) (2)}

V_{IN}=12V, T_A=25°C, unless otherwise specified.

Parameter	Conditions	MIN	TYP	MAX	unit
Input Voltage Range		4.5	---	28	V
Supply Current (Quiescent)	V _{EN} =3.0V	---	0.3	0.8	mA
Supply Current (Shutdown)	V _{EN} = 0 or EN = GND	---	---	7	uA
Feedback Voltage	TX9436A	0.585	0.600	0.615	V
	TX9437A	0.746	0.765	0.784	V
	TX9438A	0.780	0.800	0.820	V
High-Side Switch On-Resistance	I _{SW} =100mA	---	100	---	mΩ
Low-Side Switch On-Resistance	I _{SW} =-100mA	---	50	---	mΩ
Valley Switch Current Limit		3.5	---	---	A
Over Voltage Protection Threshold		---	28.5	---	V
Switching Frequency		---	500	---	KHz
Maximum Duty Cycle	V _{IN} =12V, V _{fb} =0.5V	---	92	---	%
Minimum On-Time	V _{IN} =28V, V _{out} =1.0V, I _{out} =1.0A	---	105	---	nS
EN Rising Threshold		1.4	---	---	V
EN Falling Threshold		---	---	0.5	V
Under-Voltage Lockout Threshold	Wake up VIN Voltage	---	3.8	4.2	V
	Shutdown VIN Voltage	3.0	3.4	---	V
	Hysteresis VIN voltage	---	400	---	mV
Soft Start		---	1.5	---	ms
Thermal Shutdown		---	160	---	°C
Thermal Hysteresis		---	20	---	°C

Note (1): MOSFET on-resistance specifications are guaranteed by correlation to wafer level measurements.

Note (2): Thermal shutdown specifications are guaranteed by correlation to the design and characteristics analysis.

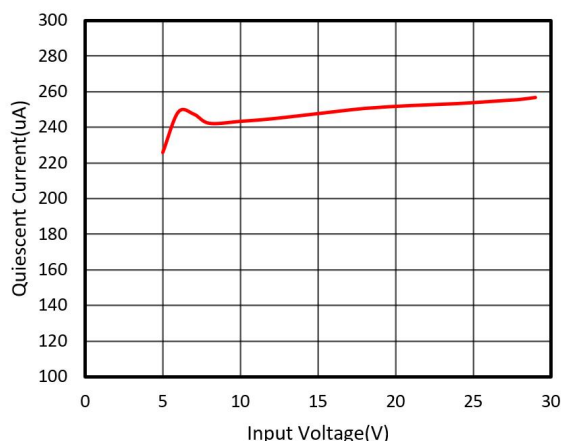


Typical Performance Characteristics ^{(1) (2)}

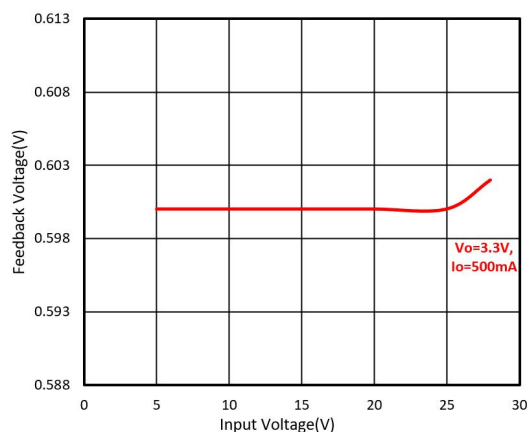
Note (1): Performance waveforms are tested on the evaluation board.

Note (2): $V_{IN} = 12V$, $V_{OUT} = 3.3V$, $T_A = +25^{\circ}C$, unless otherwise noted.

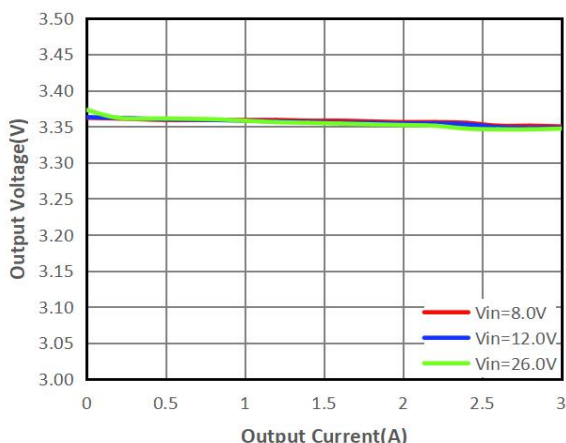
(1) Quiescent Current VS Input Voltage



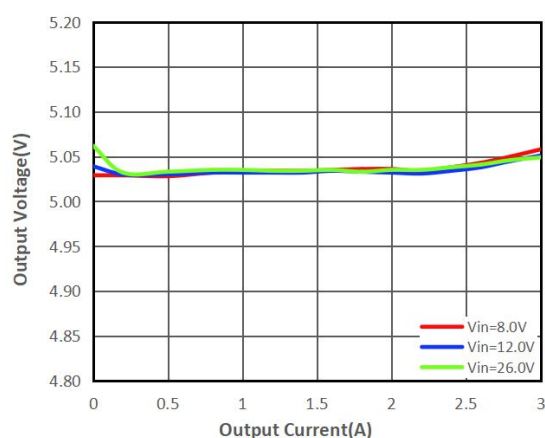
(2) Feedback Voltage VS Input Voltage



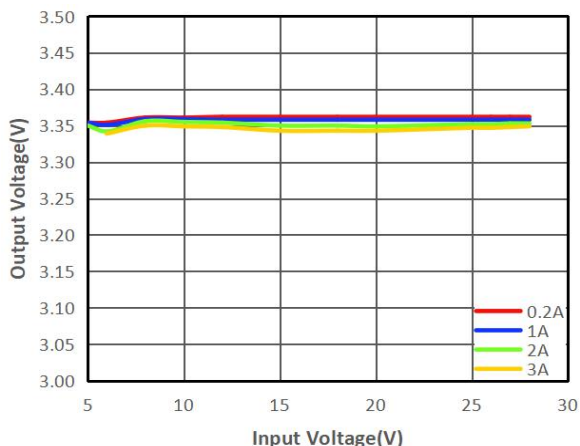
(3) Output Voltage VS Output Current ($V_{OUT} = 3.3V$)



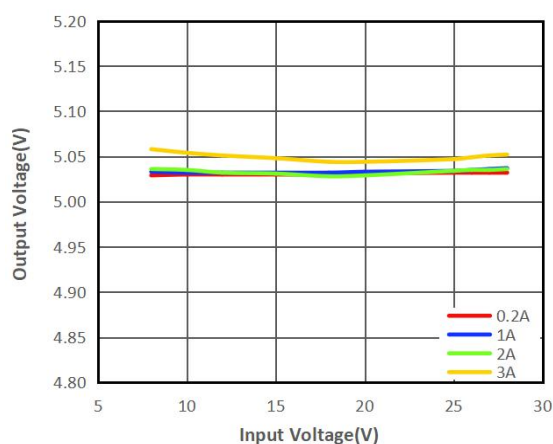
(4) Output Voltage VS Load Current ($V_{OUT} = 5.0V$)



(5) Output Voltage VS Input Voltage ($V_{OUT} = 3.3V$)



(6) Output Voltage VS Input Voltage ($V_{OUT} = 5.0V$)

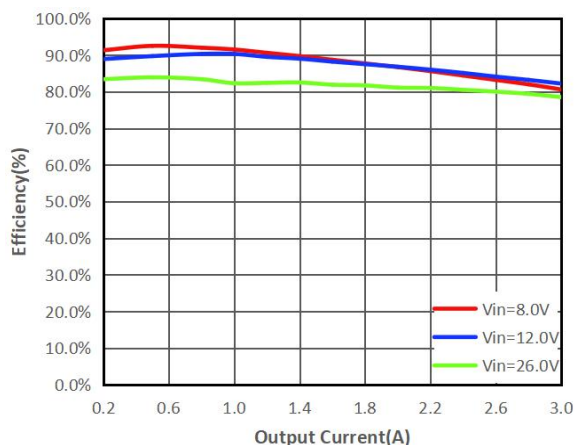




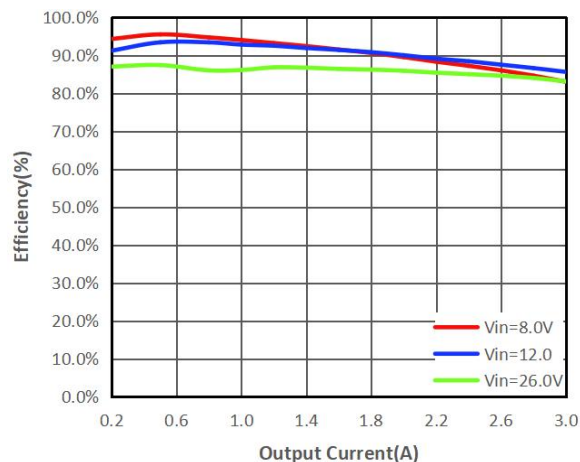
TX943XA-30EP8R Series

28V 3A 500KHz COT PSM Sync Step-Down Regulator

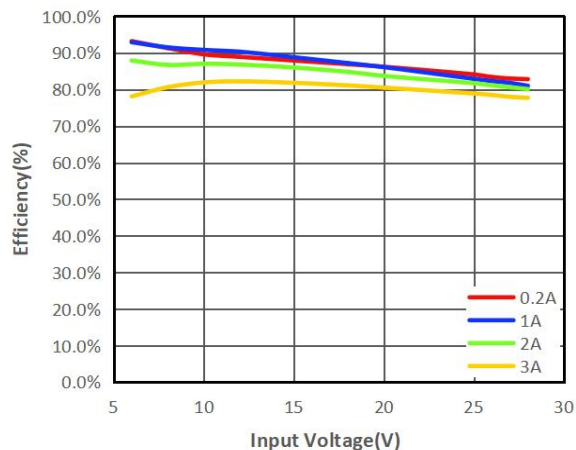
(7) Efficiency VS Output Current ($V_{OUT}=3.3V$)



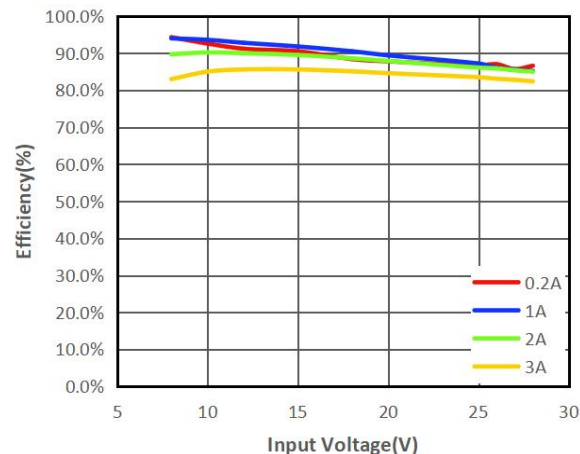
(8) Efficiency VS Output Current ($V_{OUT}=5.0V$)



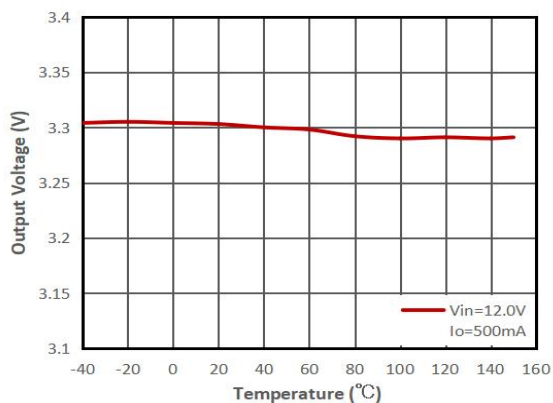
(9) Efficiency VS Input Voltage ($V_{OUT}=3.3V$)



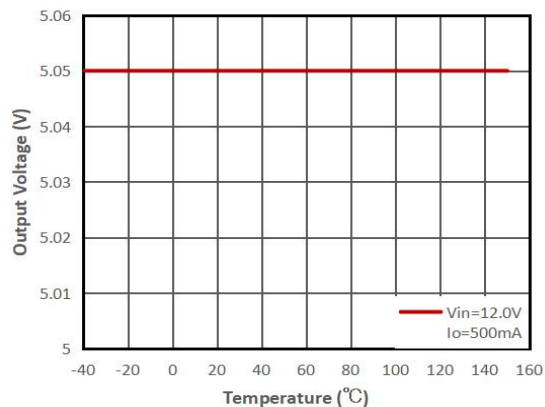
(10) Efficiency VS Input Voltage ($V_{OUT}=5.0V$)



(11) Output Voltage VS Temperature ($V_{OUT}=3.3V$)



(12) Output Voltage VS Temperature ($V_{OUT}=5.0V$)

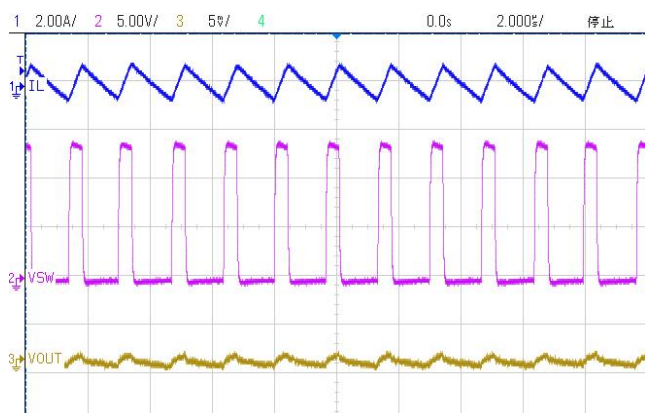




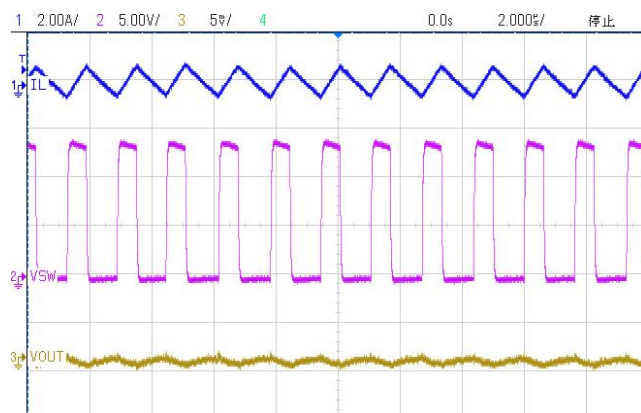
TX943XA-30EP8R Series

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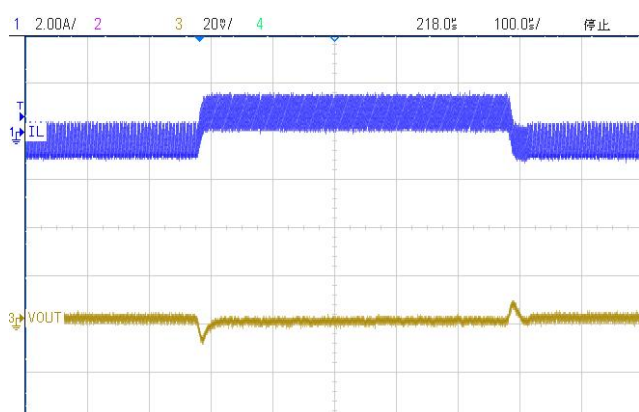
(13) Output Ripple (VIN=15.0V,VOUT=3.3V,IOUT=3A)



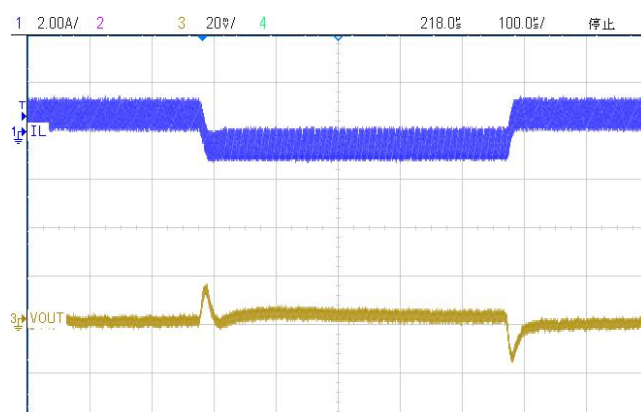
(14) Output Ripple (VIN=15.0V,VOUT=5.0V,IOUT=3A)



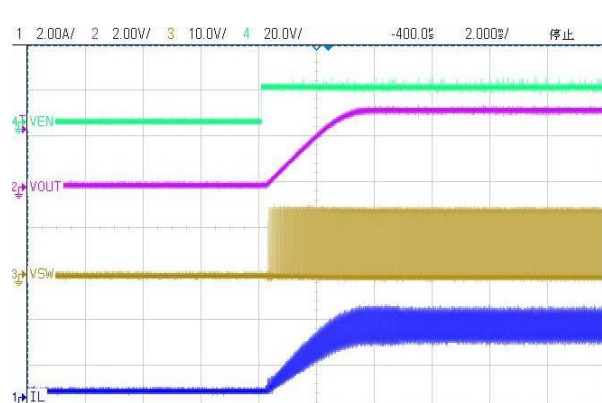
(15) Load Transient (VIN=15.0V,VOUT=3.3V,IOUT=0.5→1.8A)



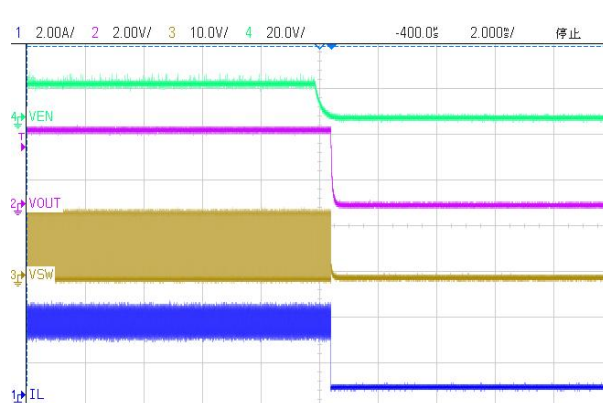
(16) Load Transient(VIN=15.0V,VOUT=5.0V,IOUT=0.5→1.8A)



(17) Enable Start Up (VIN=15.0V,VOUT=3.3V,IOUT=3A)



(18) Enable Shutdown(VIN=15.0V,VOUT=3.3V,IOUT=3A)

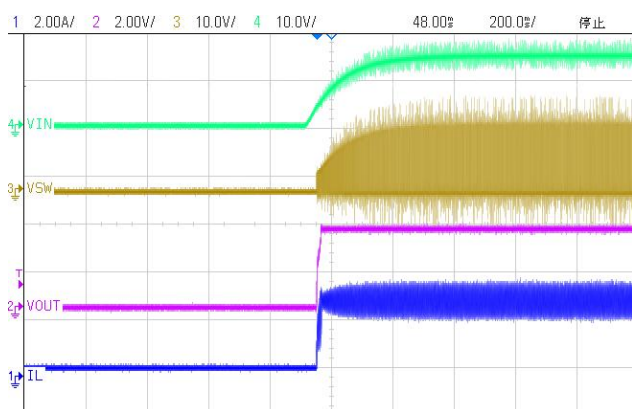




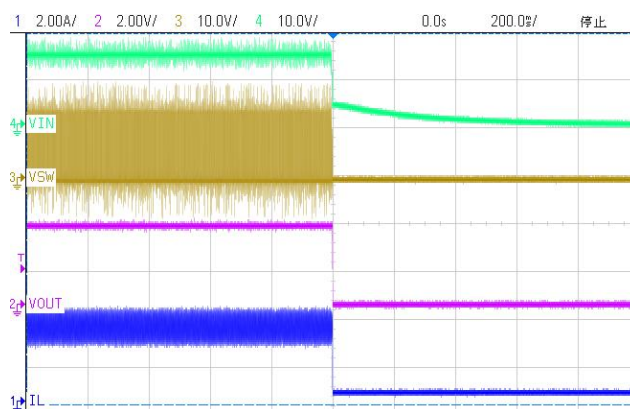
TX943XA-30EP8R Series

28V 3A 500KHz COT PSM Sync Step-Down Regulator

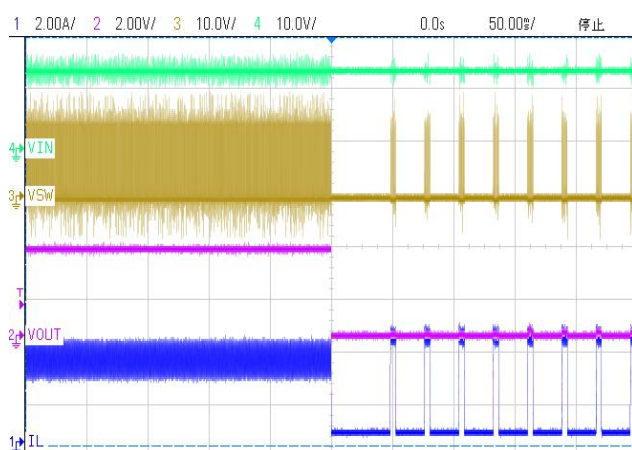
(19) Power Ramp Up (VIN=15.0V, VOUT=3.3V, IOUT=3A)



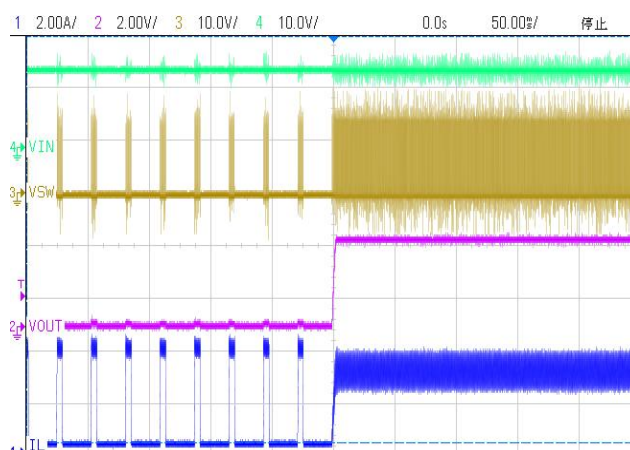
(20) Power Ramp Down (VIN=15.0V, VOUT=3.3V, IOUT=3A)



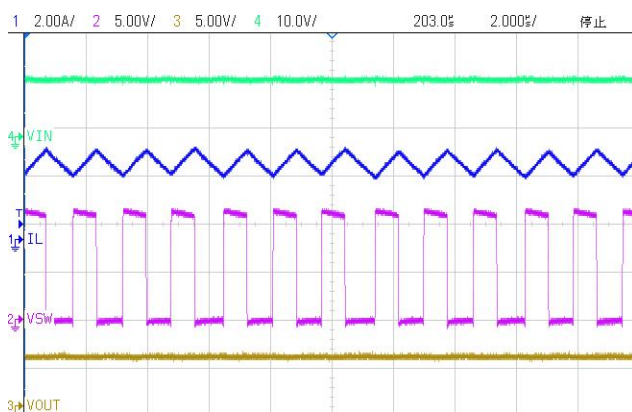
(21) Short Output (VIN=15.0V, VOUT=3.3V, IOUT=3A)



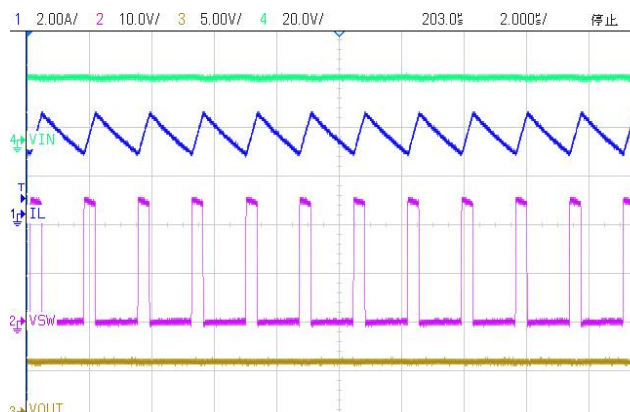
(22) Short Output Recovery (VIN=15.0V, VOUT=3.3V, IOUT=3A)



(23) Steady State (VIN=12.0V, VOUT=5.0V, IOUT=3A)



(24) Steady State (VIN=26.0V, VOUT=5.0V, IOUT=3A)





Applications Information

Setting the Output Voltage

TX943XA require an input capacitor, an output capacitor and an inductor. These components are critical to the performance of the device. TX943XA are internally compensated and do not require external components to

achieve stable operation. The output voltage can be programmed by resistor divider.

$$V_{OUT} = V_{FB} \times \frac{R1 + R2}{R2}$$

Example for VFB=0.6V

VOUT(V)	R1(KΩ)	R2(KΩ)	L1(μH)	C5(nF)	C1/C3/C4(μF)	C2/C6(μF)
1.0	6.6	10	2.2	100	22	0.1
1.2	10	10	2.2	100	22	0.1
1.5	15	10	2.2	100	22	0.1
1.8	20	10	2.2	100	22	0.1
2.5	31.7	10	2.2	100	22	0.1
3.3	45	10	3.3	100	22	0.1
5.0	73.3	10	4.7	100	22	0.1
12	190	10	10	100	22	0.1

All the external components are the suggested values, the final values are based on the application testing results.

Selecting the Inductor

The recommended inductor values are shown in the Application Diagram. It is important to guarantee the inductor core does not saturate during any foreseeable operational situation. The inductor should be rated to handle the maximum inductor peak current: Care should be taken when reviewing the different saturation current ratings that are specified by different manufacturers. Saturation current ratings are typically specified at 25°C, so ratings at maximum ambient temperature of the application should be requested from the manufacturer.

The inductor value can be calculated with:

$$L = \frac{V_{out} \times (V_{in} - V_{out})}{V_{in} \times \Delta I_L \times f_{OSC}}$$

Where ΔI_L is the inductor ripple current. Choose inductor ripple current to be approximately 30% to 40% of the maximum load current. The maximum inductor peak current can be estimated as:

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_L}{2}$$

Under light load conditions below 100mA, larger inductance is recommended for improved efficiency. Larger inductances lead to smaller ripple currents and voltages, but they also have larger physical dimensions, lower saturation currents and higher linear impedance. Therefore, the choice of inductance should be compromised according to the specific application.

Selecting the Input Capacitor

The input current to the step-down converter is discontinuous and therefore requires a capacitor to supply AC current to the step-down converter while maintaining the DC input voltage. For a better

performance, use ceramic capacitors placed as close to VIN as possible and a 0.1μF input capacitor to filter out high frequency interference is recommended. Capacitors with X5R and X7R ceramic dielectrics are



recommended because they are stable with temperature fluctuations.

The capacitors must also have a ripple current rating greater than the maximum input ripple current of the converter. The input ripple current can be estimated with Equation:

$$I_{CIN} = I_{OUT} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)}$$

From the above equation, it can be concluded that the input ripple current reaches its maximum at $V_{IN}=2V_{OUT}$

Selecting the Output Capacitor

An output capacitor is required to maintain the DC output voltage. The output voltage ripple can be estimated with Equation:

$$\Delta V_{OUT} = \frac{V_{OUT}}{F_{OSC} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \left(R_{ESR} + \frac{1}{8 \times F_{OSC} \times C_{OUT}}\right)$$

There are some differences between different types of capacitors. In the case of ceramic capacitors, the impedance at the switching frequency is dominated by the capacitance. The output voltage ripple is mainly caused by the capacitance. For simplification, the output voltage ripple can be estimated with Equation:

$$\Delta V_{OUT} = \frac{V_{OUT}}{8 \times F_{OSC}^2 \times L \times C_{OUT}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

A larger output capacitor can achieve a better load transient response, but the maximum output capacitor limitation should also be considered in the design application. If the output capacitor value is too high, the output voltage will not be able to reach the design value during the soft-start time and will fail to regulate. The

where $I_{CIN} = \frac{I_{OUT}}{2}$. For simplification, choose an input capacitor with an RMS current rating greater than half of the maximum load current.

The input capacitance value determines the input voltage ripple of the converter. If there is an input voltage ripple requirement in the system, choose the input capacitor that meets the specification. The input voltage ripple can be estimate with Equation:

$$\Delta V_{IN} = \frac{I_{OUT}}{F_{OSC} \times C_{IN}} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

Similarly, when $V_{IN}=2V_{OUT}$, input voltage ripple reaches its maximum of $\Delta V_{IN} = \frac{1}{4} \times \frac{I_{OUT}}{F_{OSC} \times C_{IN}}$.

maximum output capacitor value (COUT_MAX) can be limited approximately with Equation:

$$C_{OUT_MAX} = (I_{LIM_AVG} - I_{OUT}) \times T_{SS} / V_{OUT}$$

Where LLIM_AVG is the average start-up current during the soft-start period, and TSS is the soft- start time. On the other hand, special attention should be paid when selecting these components. The DC bias of these capacitors can result in a capacitance value that falls below the minimum value given in the recommended capacitor specifications table. The ceramic capacitor's actual capacitance can vary with temperature. The capacitor type X7R, which operates over a temperature range of -55°C to +125°C, will only vary the capacitance to within ±15%. The capacitor type X5R has a similar tolerance over a reduced temperature range of -55°C to +85°C. Many large value ceramic capacitors, larger than 1uF are manufactured with Z5U or Y5V temperature characteristics. Their capacitance can drop by more than 50% as the temperature varies from 25°C to 85°C. Therefore, X5R or X7R is recommended over Z5U and Y5V in applications where the ambient temperature will change significantly above or below 25°C.



TX943XA-20M6R Series

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Feed-Forward Capacitor (CFB)

TX943XA has internal loop compensation, so adding CFB is optional. Specifically, for specific applications, if necessary, consider whether to add feed-forward capacitors according to the situation.

The use of a feed-forward capacitor (CFB) in the feedback network is to improve the transient response or higher phase margin. For optimizing the feed-forward capacitor, knowing the cross frequency is the first thing. The cross frequency (or the converter bandwidth) can be determined by using a network analyzer. When getting the cross frequency with no feed-forward capacitor identified, the value of feed-forward capacitor (CFB) can

be calculated with the following equation:

$$C_{FB} = \frac{1}{2\pi \times F_{CROSS}} \times \sqrt{\frac{1}{R1} \times \left(\frac{1}{R1} + \frac{1}{R2}\right)}$$

Where FCROSS is the cross frequency.

To reduce transient ripple, the feed-forward capacitor value can be increased to push the cross frequency to higher region. Although this can improve transient response, it also decreases phase margin and cause more ringing. In the other hand, if more phase margin is desired, the feed-forward capacitor value can be decreased to push the cross frequency to lower region.

PCB Layout Guide

PCB layout is very important to achieve stable operation. It is highly recommended to duplicate EVB layout for optimum performance. If change is necessary, please follow these guidelines.

- 1) Keep the path of switching current short and minimize the loop area formed by Input capacitor, high-side MOSFET and low-side MOSFET.
- 2) Bypass ceramic capacitors are suggested to be put close to the Vin Pin.

- 3) Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the chip as possible.
- 4) VOUT, SW away from sensitive analog areas such as FB.
- 5) Connect IN, SW, and especially GND respectively to a large copper area to cool the chip to improve thermal performance and long-term reliability.

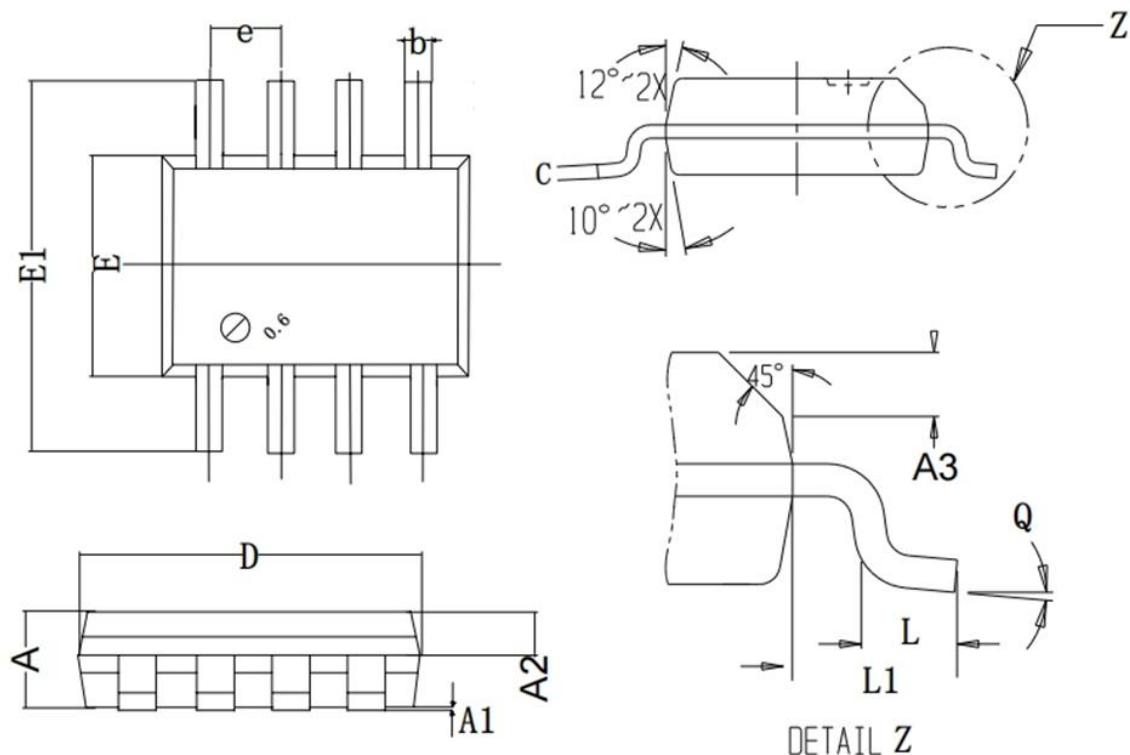


TX943XA-20M6R Series

28V 2A 500KHz COT PSM Sync Step-Down Regulator

Package Description

8-pin ESOP8 Outline Dimensions



Symbol	Dimensions In Millimeters		
	Min	Mid	Max
A	1.35	1.45	1.55
A1	0.00	0.05	0.10
A2	0.65	0.70	0.75
A3	0.35	0.40	0.45
b	0.35	0.40	0.45
c	0.18	0.20	0.22
D	4.70	4.90	5.10
e	1.27		
E1	5.80	6.10	6.20
E	3.80	3.90	4.00
L	0.40	0.60	0.80
Q	0°	/	8°
M	3.10	3.20	3.30
N	2.20	2.30	2.40
L1	1.05		



<http://www.txsemi.com>

TX943XA-20M6R Series

28V 2A 500KHz COT PSM Sync Step-Down Regulator

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